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(12) **United States Design Patent**
Yang

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(54) **DETACHABLE ASSEMBLY OF MEMORY MODULE**

(71) Applicant: **Adata Technology Co., Ltd.**, New Taipei (TW)

(72) Inventor: **Yujen Yang**, Taipei (TW)

(73) Assignee: **Adata Technology Co., Ltd.**, New Taipei (TW)

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(51) **LOC (10) Cl.** **14-02**

(52) **U.S. Cl.**
USPC **D14/436; D14/438**

(58) **Field of Classification Search**
USPC D14/435-438, 478-480; 235/441, 443, 235/487, 492, 493, 495; 361/679.32, 737, 361/679, 752, 736, 728, 796, 797, 729, 730, 361/725-727; 257/678, 679, 693, E23.064; 439/946, 948, 159; 174/250, 260, 52.1, 174/52.2; 710/300-303; 438/121

See application file for complete search history.

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Primary Examiner — Susan Moon Lee

(74) *Attorney, Agent, or Firm* — Li & Cai Intellectual Property (USA) Office

(57) **CLAIM**

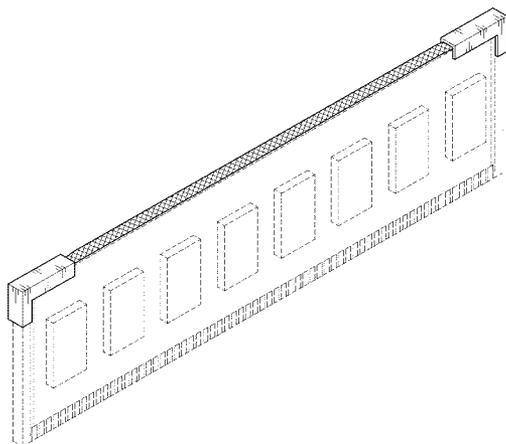
The ornamental design for a “detachable assembly of memory module,” as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a detachable assembly of memory module showing my new design; FIG. 2 is a front view thereof; FIG. 3 is a rear view thereof; FIG. 4 is a left side view thereof; FIG. 5 is a right side view thereof; FIG. 6 is a top view thereof; FIG. 7 is a bottom view thereof; and, FIG. 8 is a perspective view showing the practical usage thereof.

The broken lines depict portions of the detachable assembly of memory module which form no part of the claimed design.

1 Claim, 6 Drawing Sheets



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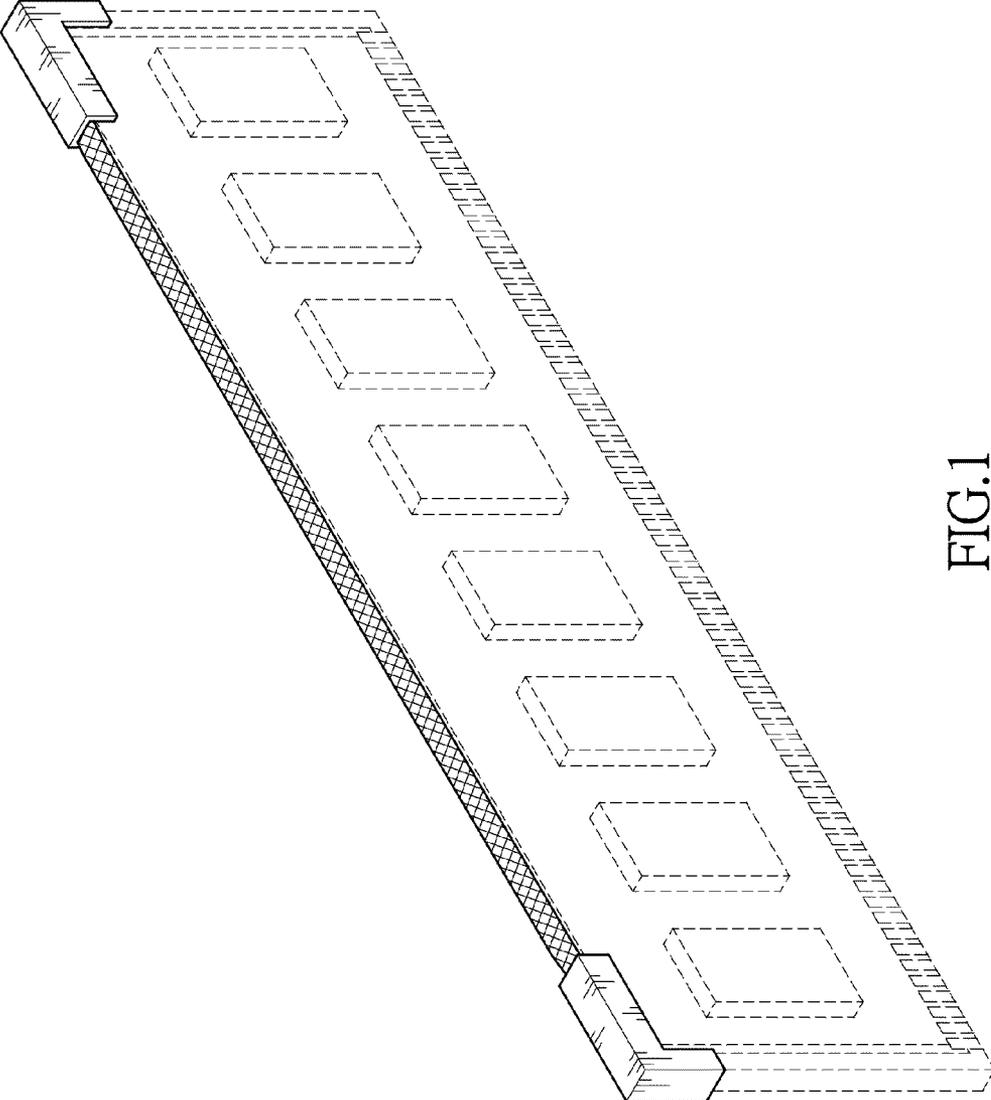


FIG.1

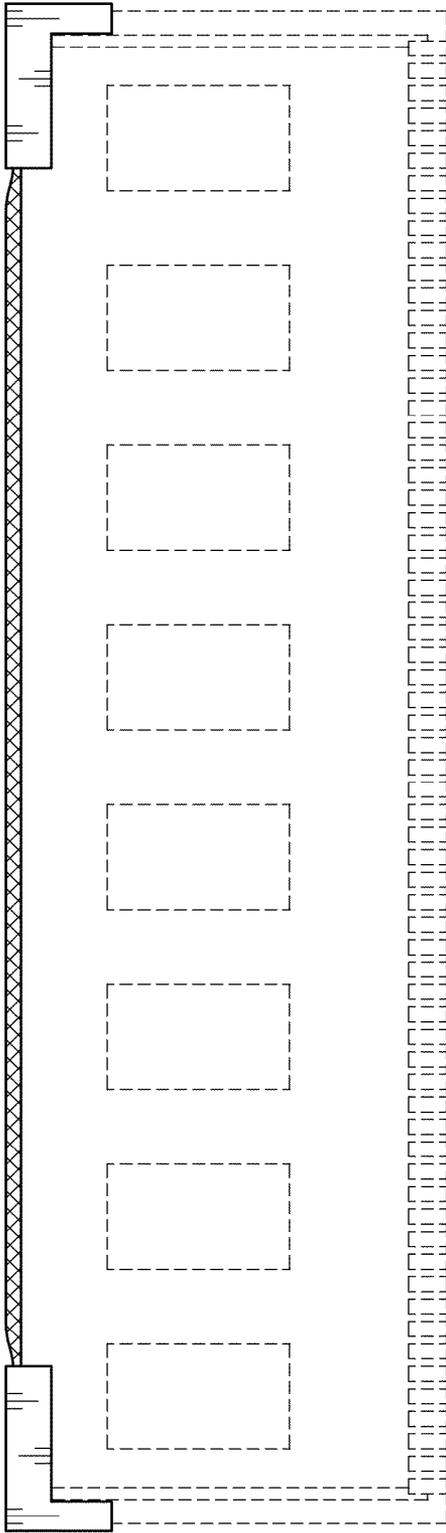


FIG.2

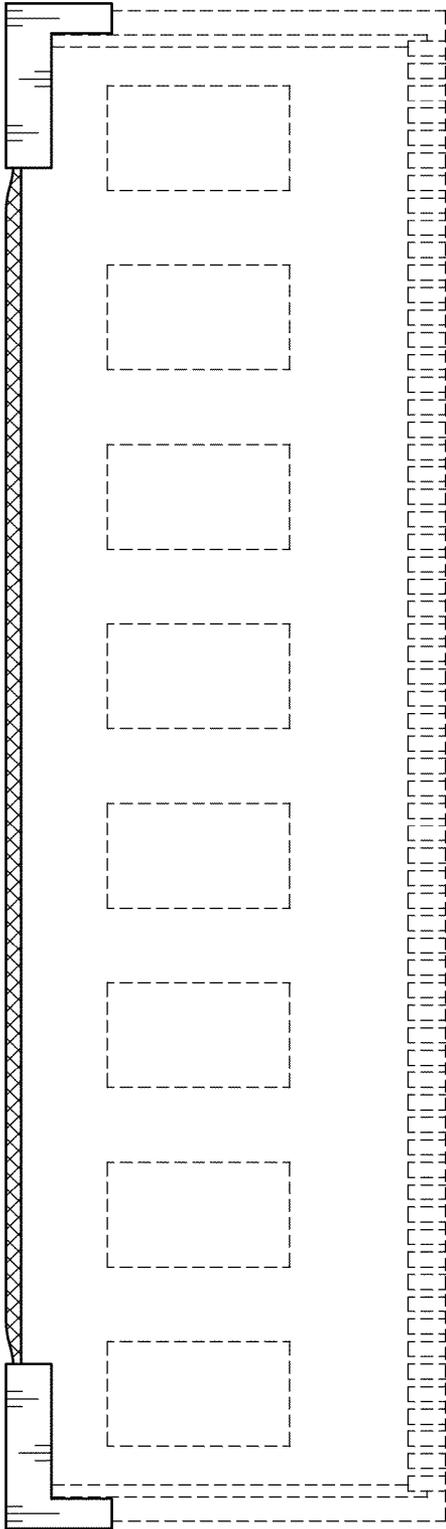


FIG.3



FIG.5



FIG.4

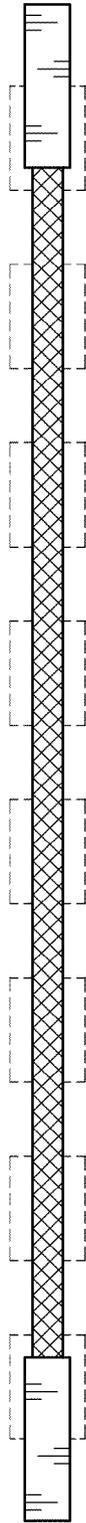


FIG. 6

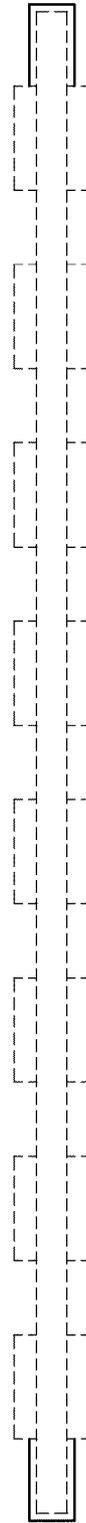


FIG. 7

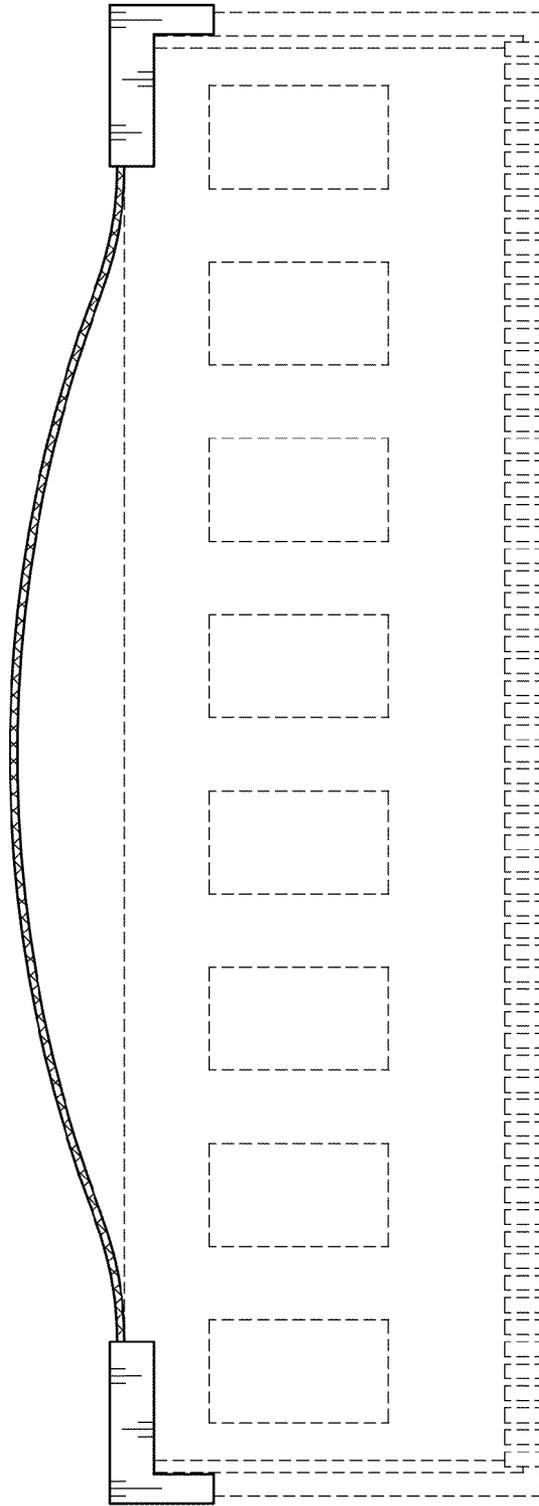


FIG. 8